

ON Semiconductor®

NC7SZ00 TinyLogic[®] UHS Two-Input NAND Gate

Features

- Ultra-High Speed: t_{PD} 2.4ns (Typical) into 50pF at 5V V_{CC}
- High Output Drive: ±24mA at 3V V_{CC}
- Broad V_{cc} Operating Range: 1.65V to 5.5V
- Matches Performance of LCX Operated at 3.3V V_{CC}
- Pow er Dow n High-Impedance Inputs/Outputs
- Over-Voltage Tolerance inputs facilitate 5V to 3V Translation
- Proprietary Noise/EMI Reduction Circuitry
- Ultra-Small MicroPak[™] Packages
- Space-Saving SOT23 and SC70 Packages

Description

The NC7SZ00 is a single two-input NAND gate from ON Semiconductor's Ultra-High Speed (UHS) series of TinyLogic[®]. The device is fabricated with advanced CMOS technology to achieve ultra-high speed with high output drive while maintaining low static power dissipation over a broad V_{CC} operating range. The device is specified to operate over the 1.65V to 5.5V V_{CC} operating range. The inputs and output are high impedance when V_{CC} is 0V. Inputs tolerate voltages up to 6V, independent of V_{CC} operating voltage.

| Part Number | Top Mark | Package | Packing Method |
|-------------|----------|---|---------------------------|
| NC7SZ00M5X | 7Z00 | 5-Lead SOT23, JEDEC MO-178 1.6mm | 3000 Units on Tape & Reel |
| NC7SZ00P5X | Z00 | 5-Lead SC70, EIAJ SC-88a, 1.25mm Wide | 3000 Units on Tape & Reel |
| NC7SZ00L6X | ΥY | 6-Lead MicroPak™, 1.00mm Wide | 5000 Units on Tape & Reel |
| NC7SZ00FHX | ΥY | 6-Lead, MicroPak2™, 1x1mm Body, .35mm Pitch | 5000 Units on Tape & Reel |

Ordering Information

Connection Diagrams





NC7SZ00 — TinyLogic[®] UHS Two-Input NAND Gate

Pin Configurations

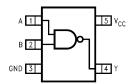


Figure 2. SC70 and SOT23 (Top View)

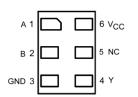


Figure 3. MicroPak™ (Top Through View)

Pin Definitions

| Pin # SC70 / SOT23 | Pin # MicroPak™ | Name | Description |
|--------------------|-----------------|-----------------|----------------|
| 1 | 1 | А | Input |
| 2 | 2 | В | Input |
| 3 | 3 | GND | Ground |
| 4 | 4 | Y | Output |
| 5 | 6 | V _{cc} | Supply Voltage |
| | 5 | NC | No Connect |

Function Table

| Inputs | | Output |
|--------|---|--------|
| Α | В | Y |
| L | L | Н |
| L | Н | Н |
| н | L | Н |
| Н | Н | L |

H = HIGH Logic Level

L = LOW Logic Level

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

| Symbol | Paramete | Min. | Max. | Unit | |
|------------------|------------------------|-------------------------|------|------|------------|
| V _{cc} | Supply Voltage | | | 6.0 | V |
| V _{IN} | DC Input Voltage | -0.5 | 6.0 | V | |
| V _{OUT} | DC Output Voltage | DC Output Voltage | | | V |
| | PC Input Diada Current | V _{IN} < -0.5V | | -50 | m ^ |
| l _{iK} | DC Input Diode Current | V _{IN} > 6.0V | | +20 | mA |

| | DC Output Diada Output | V _{OUT} < -0.5V | | -50 | |
|-------------------------------|---|----------------------------|-----|------|--------|
| ок | DC Output Diode Current | $V_{OUT} > 6V, V_{CC}=GND$ | | +20 | mA |
| lout | DC Output Current | | | ±50 | mA |
| $I_{\rm CC}$ or $I_{\rm GND}$ | DC V_{cc} or Ground Current | | | ±50 | mA |
| T _{STG} | Storage Temperature Range | | -65 | +150 | °C |
| TJ | Junction Temperature Under Bias | | | +150 | °C |
| TL | Junction Lead Temperature (Soldering, 10 Seconds) | | | +260 | °C |
| | | SOT-23 | | 200 | |
| P _D | Pow er Dissipation at +85°C | SC70-5 | | 150 | mW |
| ۲D | | MicroPak™-6 | | 130 | 1110 0 |
| | | MicroPak2™-6 | | 120 | |
| ESD | Human Body Model, JEDEC:JESD22-A114 | | | 4000 | v |
| LOD | Charge Device Model, JEDEC:JESD22-0 | C101 | | 2000 | V |

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. ON Semiconductor does not recommend exceeding them or designing to Absolute Maximum Ratings.

| Symbol | Parameter | Conditions | Min. | Max. | Unit | |
|---------------------------------|-------------------------------|-------------------------------------|------|-----------------|------|--|
| V | Supply Voltage Operating | | 1.65 | 5.50 | v | |
| V _{cc} | Supply Voltage Data Retention | | 1.5 | 5.5 | V | |
| V _{IN} | Input Voltage | | 0 | 5.5 | V | |
| V _{OUT} | Output Voltage | | 0 | V _{cc} | V | |
| T _A | Operating Temperature | | -40 | +85 | °C | |
| | | V _{cc} at 1.8V, 2.5V ±0.2V | 0 | 20 | | |
| t _r , t _f | Input Rise and Fall Times | V _{cc} at 3.3V ± 0.3V | 0 | 10 | ns/V | |
| | | V_{cc} at 5.0V ± 0.5V | 0 | 5 | | |
| | | SOT-23 | | 300 | | |
| 0 | Thermal Desistence | SC70-5 | | 435 | | |
| θ_{JA} | Thermal Resistance | MicroPak™-6 | | 500 | °C/W | |
| | | MicroPak2™-6 | | 560 | | |

Note:

1. Unused inputs must be held HIGH or LOW. They may not float.

| 0 | Demonster (| | Condition - | Г | _A =25°(| 0 | T _A =-40 t | o +85°C | L ha it - |
|---------------------------------------|------------------------------|-----------------|---|---------------------|--------------------|---------------------|-----------------------|---------------------|-----------|
| Symbol Parameter | Parameter | V _{cc} | Conditions | Min. | Тур. | Max. | Min. | Max. | Units |
| M | HIGH Level Input | 1.65 to 1.95 | | $0.75V_{\text{CC}}$ | | | $0.75V_{\text{CC}}$ | | |
| VIH | Voltage | 2.30 to 5.50 | | $0.70V_{\text{CC}}$ | | | $0.70V_{\text{CC}}$ | | V |
| N/ | LOW Level Input | 1.65 to 1.95 | | | | $0.25V_{\text{CC}}$ | | $0.25V_{\text{CC}}$ | V |
| VIL | Voltage | 2.30 to 5.50 | | | | $0.30V_{\text{CC}}$ | | $0.30V_{\text{CC}}$ | V |
| | | 1.65 | | 1.55 | 1.65 | | 1.55 | | |
| | | 1.80 | | 1.70 | 1.80 | | 1.70 | | |
| | | 2.30 | V _{IN} =V _{IL} I _{OH} =-100µА | 2.20 | 2.30 | | 2.20 | | |
| V _{он} HIGH Level Voltage | | 3.00 | | 2.90 | 3.00 | | 2.90 | | |
| | HIGH Level Output Voltage | 4.50 | | 4.40 | 4.50 | | 4.40 | | V |
| | | 1.65 | I _{OH} =-4mA | 1.29 | 1.52 | | 1.29 | | |
| | | 1.80 | I _{OH} =-8mA | 1.90 | 2.15 | | 1.90 | | |
| | | 2.30 | I _{OH} =-16mA | 2.40 | 2.80 | | 2.40 | | |
| | | 3.00 | I _{OH} =-24mA | 2.30 | 2.68 | | 2.30 | | |
| | | 4.50 | I _{OH} =-32mA | 3.80 | 4.20 | | 3.80 | | |
| | | 1.65 | | | 0.00 | 0.10 | | 0.08 | |
| | | 2.30 | | | 0.00 | 0.10 | | 0.10 | |
| | | 3.00 | V _{IN} =V _{IH} I _{OL} =100µA | | 0.00 | 0.10 | | 0.10 | |
| | | 3.00 | | | 0.00 | 0.10 | | 0.10 | |
| N/ | LOW Level Output | 4.50 | | | 0.00 | 0.10 | | 0.10 | V |
| Vol | Voltage | 1.65 | I _{OL} =4mA | | 0.80 | 0.24 | | 0.24 | V |
| | | 2.30 | I _{OL} =8mA | | 0.10 | 0.30 | | 0.30 | |
| | | 3.00 | I _{OL} =16mA | | 0.15 | 0.40 | | 0.40 | |
| | | 3.00 | I _{OL} =24mA | | 0.22 | 0.55 | | 0.55 | |
| | | 4.50 | I _{OL} =32mA | | 0.22 | 0.55 | | 0.55 | |
| I _{IN} | Input Leakage Current | 0 to 5.5 | V _{IN} =5.5V, GND | | | ±1 | | ±10 | μA |
| I _{OFF} | Power Off | 0 | V_{IN} or V_{OUT} =5.5V | | | 1 | | 10 | μA |
| I _{CC} | Quiescent Supply Current | 1.65 to 5.50 | V _{IN} =5.5V, GND | | | 2 | | 20 | μA |

| AC Ele | AC Electrical Characteristics | | | | | | | | | | |
|-----------------------------------|-------------------------------|-----------------|----------------------|------|--------|------|------------------------------|------|-------|----------|----------------------|
| Symbol | | | | T, | ₄=25°C | | T _A =-40 to +85°C | | Units | Figure | |
| Symbol | Parameter | V _{cc} | Conditions | Min. | Тур. | Max. | Min. | Max. | Units | Figure | |
| | - | 1.65 | | 2.0 | 5.4 | 11.4 | 2.0 | 12.0 | | | |
| | | 1.80 | $R_{L}=1$ MIS2 | 2.0 | 4.5 | 9.5 | 2.0 | 10.0 | ns | | |
| | | 2.50 ± 0.20 | | 0.8 | 3.0 | 6.5 | 0.8 | 7.0 | | | |
| $t_{\text{PHL}}, t_{\text{PLH}}$ | Propagation Delay | 3.30 ± 0.30 | | 0.5 | 2.4 | 4.5 | 0.5 | 4.7 | | ns | Figure 4 Figure 5 |
| | | 5.00 ± 0.50 | | 0.5 | 2.0 | 3.9 | 0.5 | 4.1 | | 0 | |
| | | 3.30 ± 0.30 | C∟=50pF, | 1.5 | 2.9 | 5.0 | 1.5 | 5.2 | | | |
| | 5.00 ± 0 | 5.00 ± 0.50 | R _L =500Ω | 0.8 | 2.4 | 4.3 | 0.8 | 4.5 | | | |
| CIN | Input Capacitance | 0.00 | | | 4 | | | | pF | | |
| CPD | Power Dissipation | 3.30 | | | 24 | | | | ηE | Figure 6 | |
| CPD | Capacitance ⁽²⁾ | 5.00 | | | 30 | | | | рF | | |

Note:

2. C_{PD} is defined as the value of the internal equivalent capacitance derived from dynamic operating current consumption (I_{CCD}) at no output lading and operating at 50% duty cycle. C_{PD} is related to I_{CCD} dynamic operating current by the expression: $I_{CCD}=(C_{PD})(V_{CC})(f_{IN})+(I_{CC}\text{static})$.

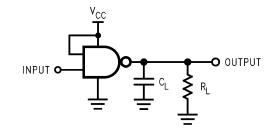
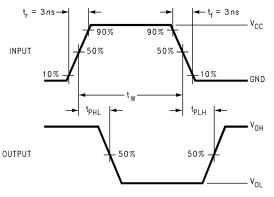
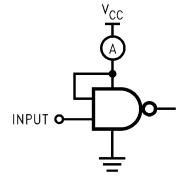


Figure 4. AC Test Circuit







Note:

3. Input=AC Waveform; t_r=t_f=1.8ns; PRR=10MHz; Duty Cycle =50%.

Figure 6. I_{CCD} Test Circuit

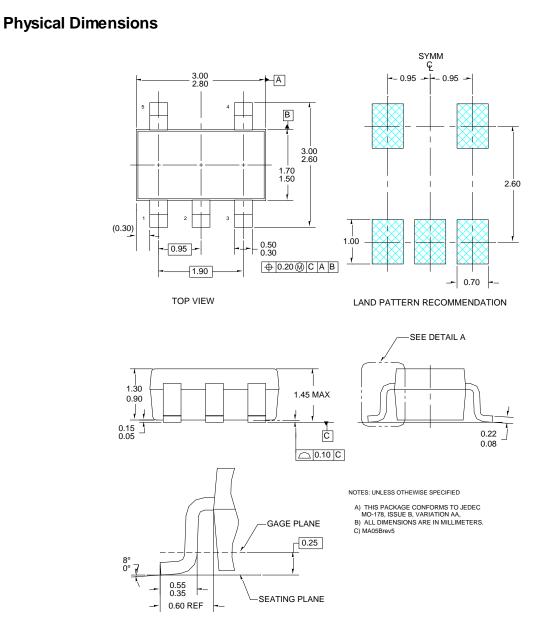


Figure 7. 5-Lead SOT23, JEDEC MO-178 1.6mm

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Tape and Reel Specifications

| Package Designator | Tape Section | on Cavity Number Cavity Status | | Cover Type Status |
|--------------------|--------------------|--------------------------------|--------|----------------------|
| | Leader (Start End) | 125 (Typical) | Empty | Sealed |
| M5X | Carrier | 3000 | Filled | Sealed |
| | Trailer (Hub End) | 75 (Typical) | Empty | Sealed |

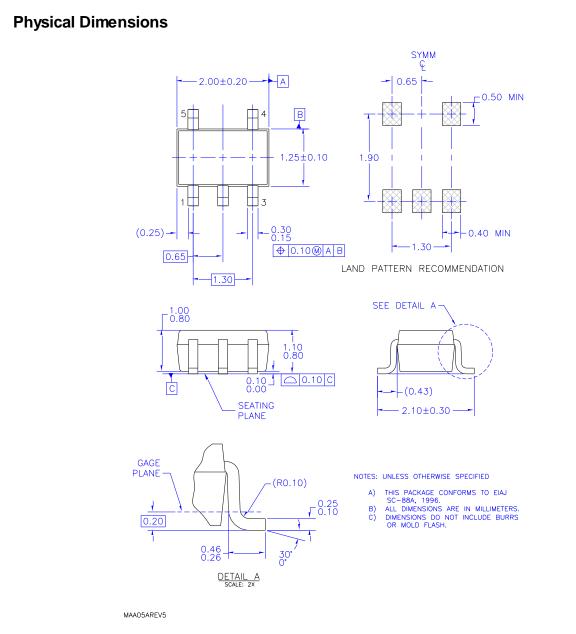
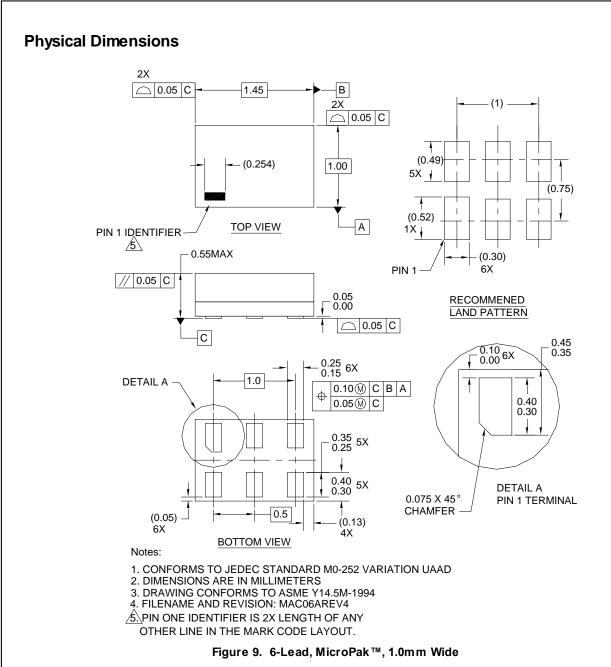


Figure 8. 5-Lead, SC70, EAJ SC-88a, 1.25mm Wide

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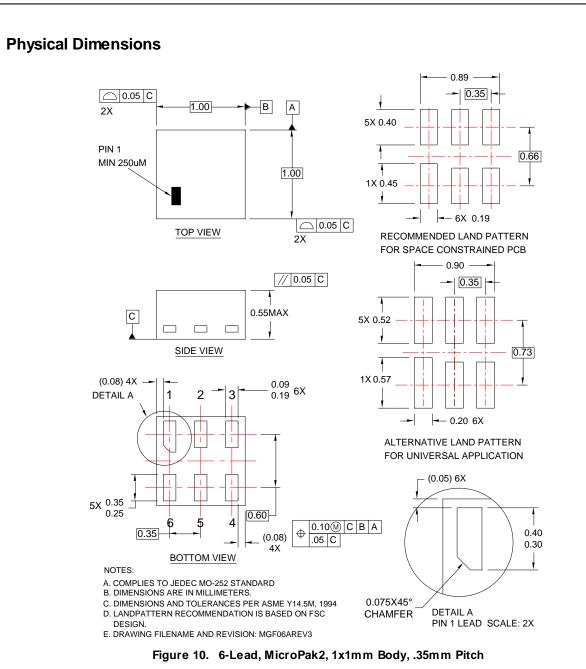
| Package Designator | Tape Section | Cavity Number | Cavity Status | Cover Type Status |
|--------------------|--------------------|---------------|---------------|----------------------|
| | Leader (Start End) | 125 (Typical) | Empty | Sealed |
| P5X | Carrier | 3000 | Filled | Sealed |
| | Trailer (Hub End) | 75 (Typical) | Empty | Sealed |



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Tape and Reel Specifications

| Package Designator | Tape Section | be Section Cavity Number Cavity Status | | Cover Type Status |
|--------------------|--------------------|--|--------|----------------------|
| | Leader (Start End) | 125 (Typical) | Empty | Sealed |
| L6X | Carrier | 5000 | Filled | Sealed |
| | Trailer (Hub End) | 75 (Typical) | Empty | Sealed |



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Tape and Reel Specifications

| Package Designator | Tape Section | e Section Cavity Number Cavity Status | | Cover Type Status |
|--------------------|--------------------|---------------------------------------|--------|----------------------|
| | Leader (Start End) | 125 (Typical) | Empty | Sealed |
| FHX | Carrier | 5000 | Filled | Sealed |
| | Trailer (Hub End) | 75 (Typical) | Empty | Sealed |

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